



- NOTES:
- MATERIAL:
 - Housing:HI-TEMP.PLASIC ULS4V-0; Color Black.
 - Terminal:Copper Alloy.
 - Shell:SUS.
 - PLATING:
 - Contact: Contact Area: Au G/F, Solder area: Matte tin
.Under plate Ni all over
 - SHELL: Solder Area: Au G/F, Under plate Ni all over
 - CD PIN: Contact Area: Au G/F, Under plate all over
 - SPECIALITY:
 - Rated current: 1.0A
 - Rated voltage: 30V
 - Contact Resistance: 50mΩ MAX
 - Insulation Resistance: 1000MΩ MIN 500V DC
 - Dielectric withstanding voltage: 500V AC.
 - Solder ability: 255±5°C, 5±0.5s.
 - Durability: 10000 Cycles Min.
 - Operating condition: Temperature: -40°C ~ +85°C; Humidity 80% R.H MAX

Pin No.		MICRO SD
PIN1	DAT2	1P
PIN2	CD/DAT3	2P
PIN3	CMD	3P
PIN4	VDD	4P
PIN5	CLK	5P
PIN6	VSS	6P
PIN7	DAT0	7P
PIN8	DAT1	8P
PIN9		
PIN10	CARD DETECT	

Switch card state



ITEM	PART NAME	QTY	MATERIAL	FINISHING
③	Shell	1	SUS	
②	Terminal	10	COPPER ALLOY	
①	Housing	1	HI-TEMP.PLASIC UL 94V-0	BLACK

MARK	DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES	DSND	DATE	SCALE: N/A	MODEL TYPE:
ΔX					ANGULAR ±5°	DWN	DATE	VIEW:	TF CARD CONN
ΔX					L ≤ 4 ±0.2	CHKD	DATE	UNIT: mm	PART NO.:
ΔX					4 < L ≤ 16 ±0.3	APPD	DATE	SIZE: A4	DWG NO.:
					16 < L ≤ 63 ±0.4				XKTF-001C
					L > 63 ±0.5				WEIGHT 1.0g
									SHEET 1/1
									REVISION A0